

Technical Data Sheet (Preliminary)
White SMD Surface Mount Device

67-23B UWC/TR8

Features

- Fluorescence Type
- High Luminous Intensity
- High Efficiency
- Emission Color:x=0.29,y=0.30
- Pb-free



Descriptions

The white LED which was fabricated using a blue LED and a phosphor, and the phosphor is excited by blue light and emits yellow fluorescence. The mixture of blue light and yellow light results in a white emission.

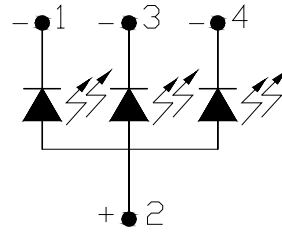
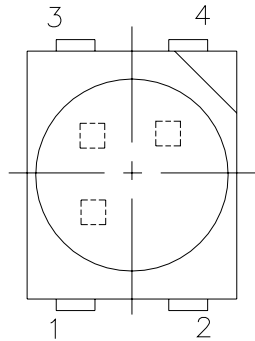
Applications

- OA Equipment
- Backlighting of Full Color LCD
- Automotive Equipment
- Replacement of Conventional Light Bulbs and Fluorescent Lamps

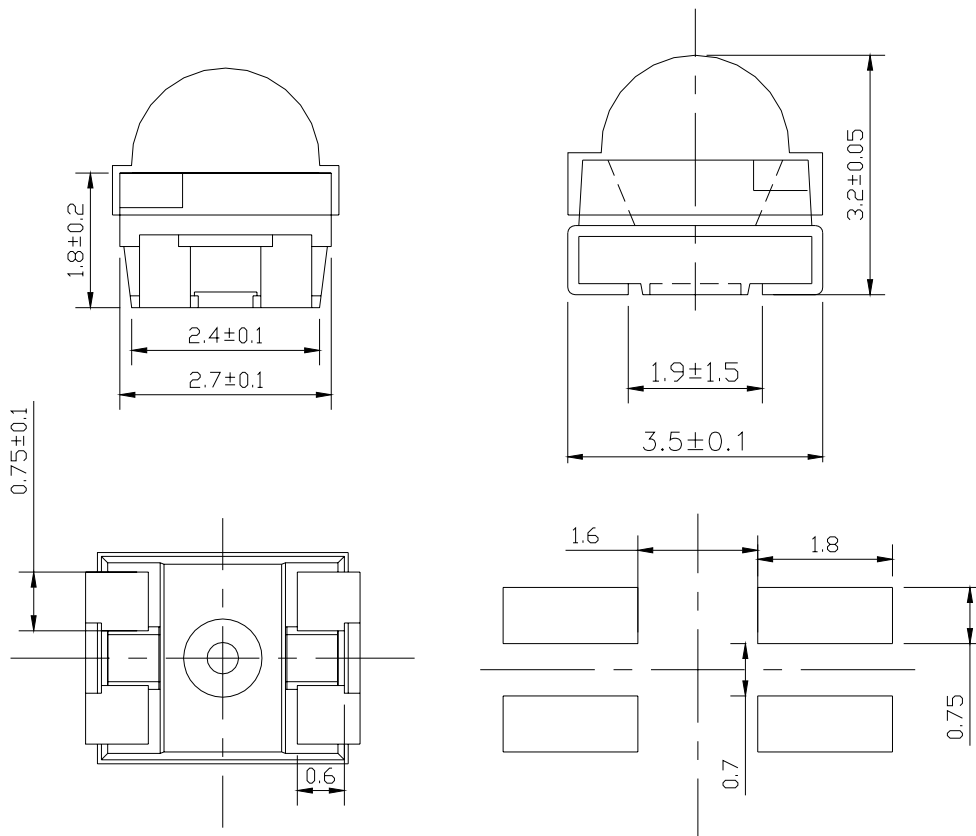
Device Selection Guide

Chip		Lens Color
Material	Emitted Color	
InGaN	White	Water Clear

Package Outline Dimensions



Polarity



Notes:

1. All dimensions are in millimeters
2. tolerance Unless Dimension = $\pm 0.05\text{mm}$

67-23B UWC/TR8
Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V _R	5	V
Operating Temperature	T _{opr}	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40~ +100	°C
Soldering Temperature	T _{sol}	260 (for 5 second)	°C
Electrostatic Discharge	ESD	150	V
Power Dissipation	P _d	110	mW
*Forward Current	I _F	25	mA
*Peak Forward Current(Duty 1/10 @ 1KHz)	I _{FP}	100	mA

*. Maximum forward current for each die.

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Units	Condition
Luminous Intensity	I _V	1600	1950	--	mcd	I _F =60mA
Forward Voltage	V _F	--	3.5	4.0	V	I _F =20mA
Reverse Current*1	I _R	--	--	50	μA	V _R =5V
Viewing Angle	2θ 1/2	--	60	--	deg	I _F =60mA

*1 For each die.

The products are sensitive to static electricity and care must be fully taken when handling products.

67-23B UWC/TR8

Color Ranks

	Rank A0			
x	0.280	0.264	0.283	0.296
y	0.248	0.267	0.305	0.276

	B3			
x	0.287	0.283	0.304	0.307
y	0.295	0.305	0.33	0.315

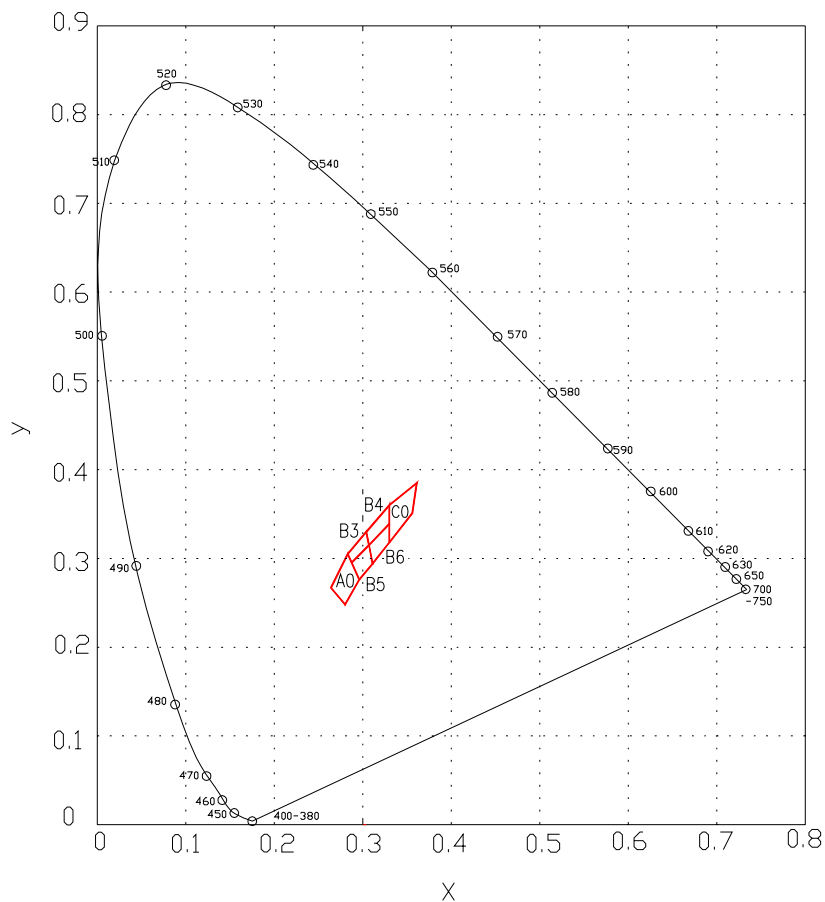
	B4			
x	0.307	0.304	0.330	0.330
y	0.315	0.330	0.360	0.339

	B5			
x	0.296	0.287	0.307	0.311
y	0.276	0.295	0.315	0.294

	B6			
x	0.311	0.307	0.330	0.330
y	0.294	0.315	0.339	0.318

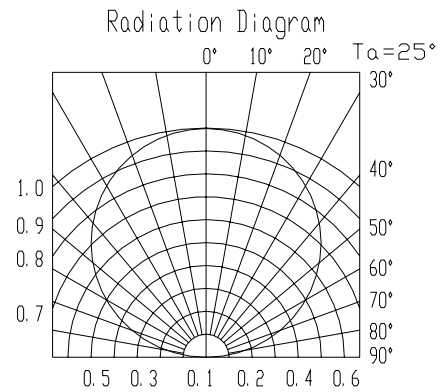
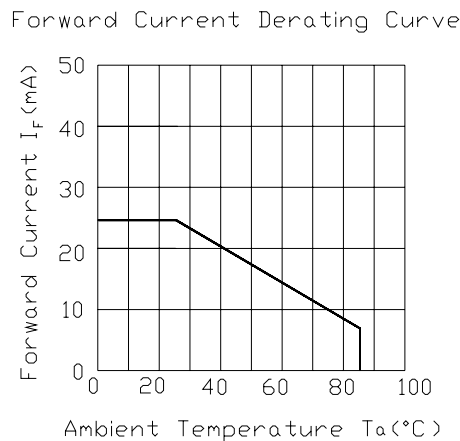
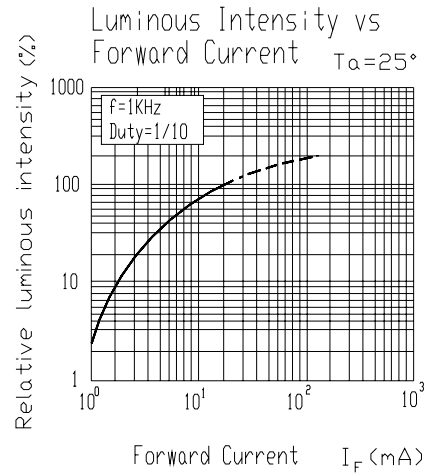
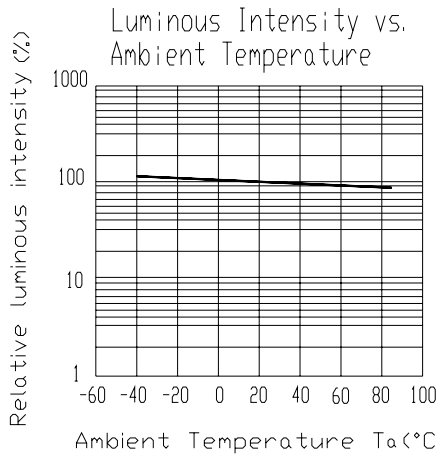
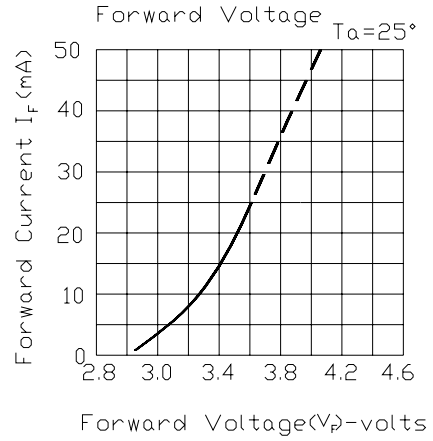
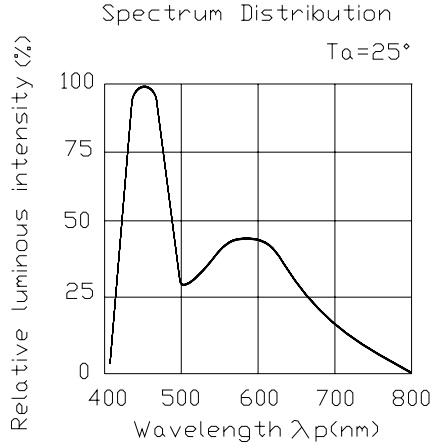
	Rank C0			
x	0.330	0.330	0.361	0.356
y	0.318	0.360	0.385	0.351

CIE Chromaticity Diagram



*The C.I.E. 1931 chromaticity diagram (Tolerance ± 0.02).

Typical Electro-Optical Characteristics Curves



Label explanation

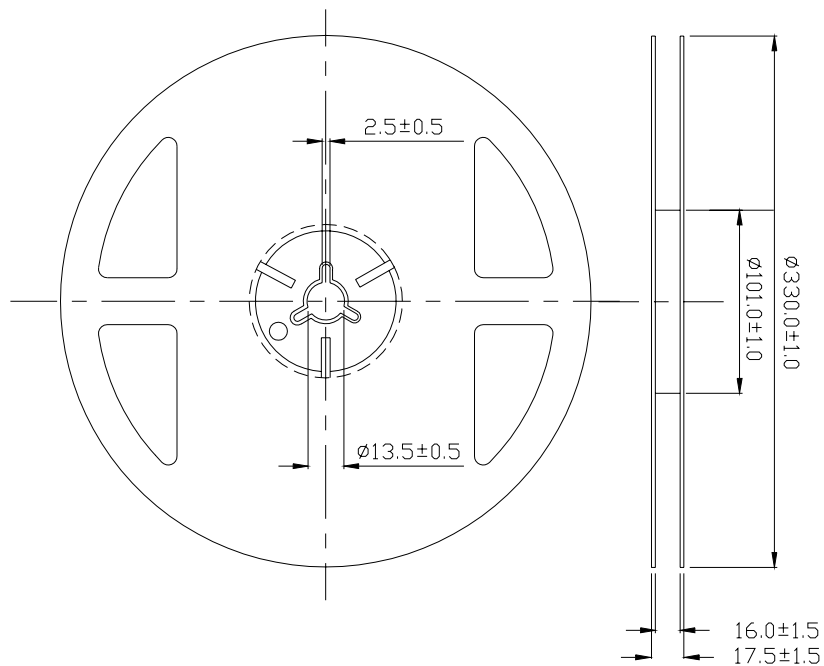
CAT: Luminous Intensity Rank

HUE: Chromaticity Coordinates Rank

REF: Forward Voltage Rank

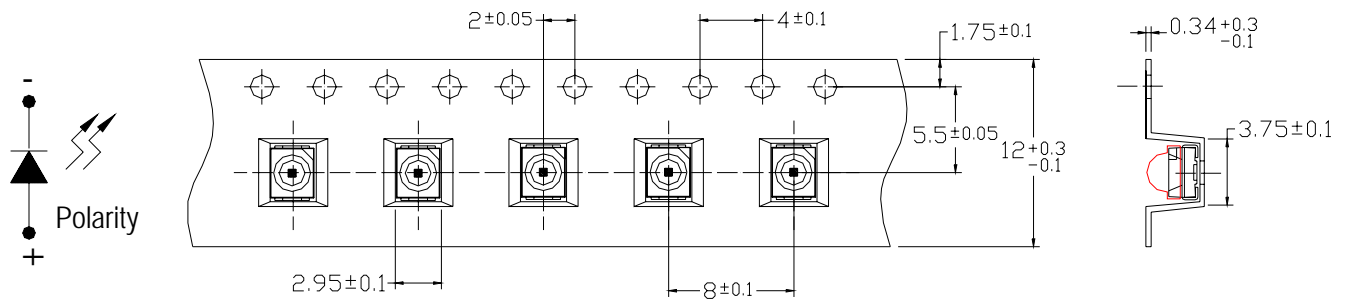


Reel Dimensions



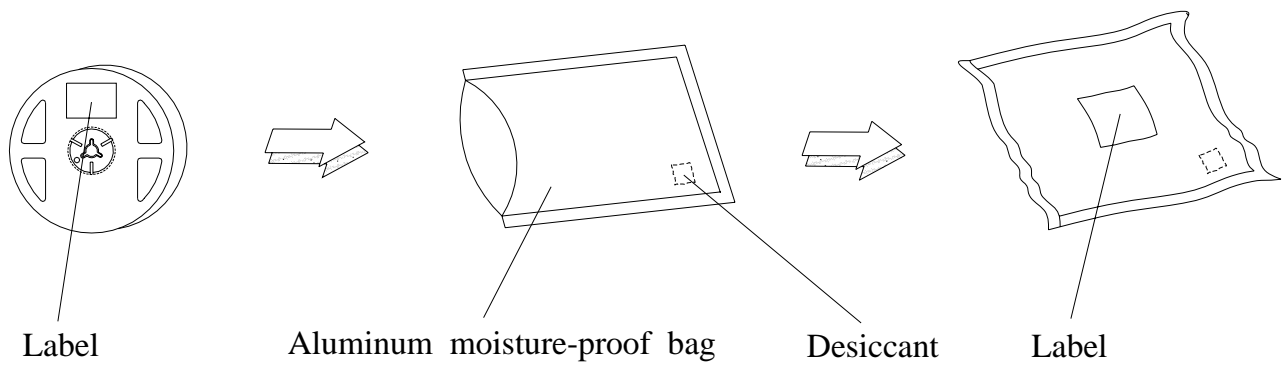
Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel.



Note: Tolerances Unless Dimension $\pm 0.1\text{mm}$, Unit = mm

Moisture Resistant Packaging



67-23B UWC/TR8**Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

LTPD : 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C ±5°C Min. 5 sec.	6 Min.	22 Pcs.	0/1
2	Temperature Cycle	H : +100°C 15min § 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H : +100°C 5min § 10 sec L : -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	I _F = 20 mA / 25°C	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/85%RH	1000 Hrs.	22 PCS.	0/1

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.

2.3 The LEDs should be used within a year.

2.4 After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less.

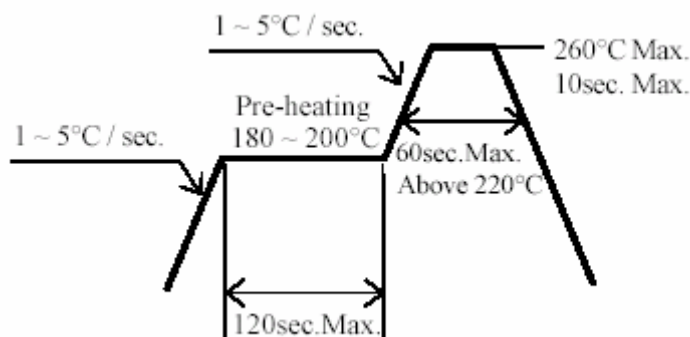
2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

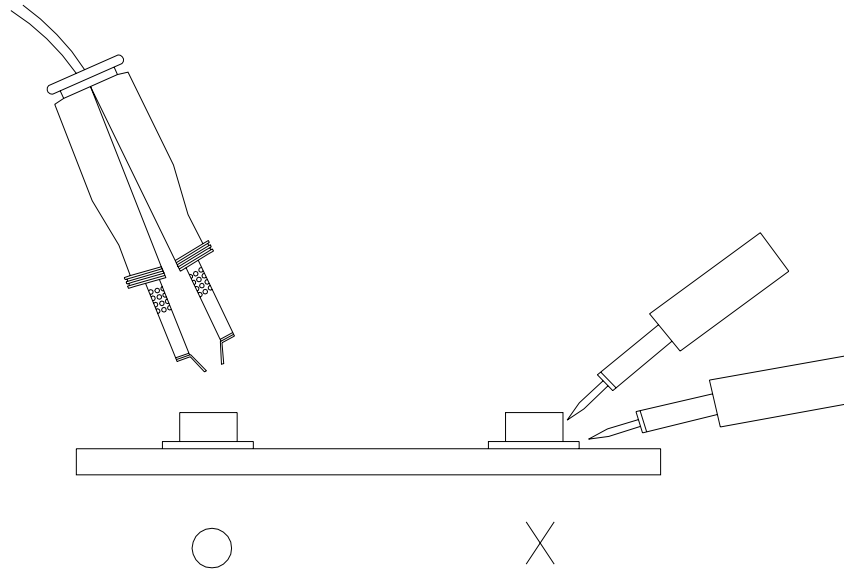
3.4 After soldering, do not warp the circuit board.

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 280°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.
Office: No 25, Lane 76, Sec 3, Chung Yang Rd,
Tucheng, Taipei 236, Taiwan, R.O.C

Tel: 886-2-2267-2000, 2267-9936
Fax: 886-2267-6244, 2267-6189, 2267-6306
<http://www.everlight.com>